

MAGX-000035-015000

MAGX-000035-01500S



GaN on SiC HEMT Pulsed Power Transistor
15 W, DC - 3.5 GHz

Rev. V1

Features

- GaN on SiC Depletion Mode Transistor
- Common-Source Configuration
- Broadband Class AB Operation
- Thermally Enhanced Package (Flanged: Cu/W, Flangeless: Cu)
- RoHS* Compliant
- +50V Typical Operation
- MTTF = 600 years ($T_J < 200^\circ\text{C}$)

Primary Applications

- Commercial Wireless Infrastructure (WCDMA, LTE, WiMAX)
- Air Traffic Control Radar - Commercial
- Weather Radar - Commercial
- Military Radar - Military
- Public Radio
- Industrial, Scientific and Medical
- SATCOM
- Instrumentation

Description

The MAGX-000035-01500X is a gold-metalized unmatched Gallium Nitride (GaN) on Silicon Carbide RF power transistor suitable for a variety of RF power amplifier applications. Using state of the art wafer fabrication processes, these high performance transistors provide high gain, efficiency, bandwidth, and ruggedness over multiple octave bandwidths for today's demanding application needs.

The MAGX-000035-01500X is constructed using a thermally enhanced flanged (Cu/W) or flangeless (Cu) ceramic package which provides excellent thermal performance. High breakdown voltages allow for reliable and stable operation in extreme mismatched load conditions unparalleled with older semiconductor technologies.

MAGX-000035-015000 (Flanged)



MAGX-000035-01500S (Flangeless)



Ordering Information

| Part Number | Description |
|--------------------|---|
| MAGX-000035-015000 | Flanged, Bulk Packaging |
| MAGX-000035-01500S | Flangeless, Bulk Packaging |
| MAGX-L20035-015000 | Sample Board (1.2 - 1.4 GHz, Flanged) |
| MAGX-L20035-01500S | Sample Board (1.2 - 1.4 GHz, Flangeless) |

1 * Restrictions on Hazardous Substances, European Union Directive 2002/95/EC.

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Electrical Specifications¹: Freq. = 1.2 - 1.4 GHz, T_A = 25°C

| Parameter | Test Conditions | Symbol | Min. | Typ. | Max. | Units |
|---|-------------------------|------------------|------|------|------|-------|
| RF Functional Tests: V_{DD} = 50 V, I_{DQ} = 15 mA, 1 ms Pulse, 10% Duty | | | | | | |
| Output Power | P _{IN} = 0.5 W | P _{OUT} | 15.0 | 17.7 | - | W |
| Power Gain | P _{IN} = 0.5 W | G _P | 14.8 | 15.5 | - | dB |
| Drain Efficiency | P _{IN} = 0.5 W | η _D | 55 | 63 | - | % |
| Droop | P _{IN} = 0.5 W | Droop | - | 0.1 | 0.4 | dB |
| Load Mismatch Stability | P _{IN} = 0.5 W | VSWR-S | - | 5:1 | - | - |
| Load Mismatch Tolerance | P _{IN} = 0.5 W | VSWR-T | - | 10:1 | - | - |

Electrical Characteristics: T_A = 25°C

| Parameter | Test Conditions | Symbol | Min. | Typ. | Max. | Units |
|--------------------------------|---|---------------------|------|------|------|-------|
| DC Characteristics | | | | | | |
| Drain-Source Leakage Current | V _{GS} = -8 V, V _{DS} = 175 V | I _{DS} | - | - | 750 | μA |
| Gate Threshold Voltage | V _{DS} = 5 V, I _D = 2 mA | V _{GS(TH)} | -5 | -3 | -2 | V |
| Forward Transconductance | V _{DS} = 5 V, I _D = 500 mA | G _M | 0.35 | - | - | S |
| Dynamic Characteristics | | | | | | |
| Input Capacitance | V _{DS} = 0 V, V _{GS} = -8 V, F = 1 MHz | C _{ISS} | - | 4.4 | - | pF |
| Output Capacitance | V _{DS} = 50 V, V _{GS} = -8 V, F = 1 MHz | C _{OSS} | - | 1.9 | - | pF |
| Reverse Transfer Capacitance | V _{DS} = 50 V, V _{GS} = -8 V, F = 1 MHz | C _{RSS} | - | 0.2 | - | pF |

Correct Device Sequencing

Turning the device ON

1. Set V_{GS} to the pinch-off (V_P), typically -5 V.
2. Turn on V_{DS} to nominal voltage (+50V).
3. Increase V_{GS} until the I_{DS} current is reached.
4. Apply RF power to desired level.

Turning the device OFF

1. Turn the RF power off.
2. Decrease V_{GS} down to V_P.
3. Decrease V_{DS} down to 0 V.
4. Turn off V_{GS}.

1. Electrical Specifications measured in MACOM RF evaluation board.

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Absolute Maximum Ratings^{2,3,4}

| Parameter | Absolute Max. |
|--|---------------------------|
| Input Power | P_{IN} (nominal) + 3 dB |
| Drain Supply Voltage, V_{DD} | +65 V |
| Gate Supply Voltage, V_{GG} | -8 V to 0 V |
| Supply Current, I_{DD} | 800 mA |
| Power Dissipation (P_{AVG}), Pulsed @ 85°C | 10.3 W |
| MTTF ($T_J < 200^\circ\text{C}$) | 600 years |
| Junction Temperature ⁵ | 200°C |
| Operating Temperature | -40°C to +95°C |
| Storage Temperature | -65°C to +150°C |
| Mounting Temperature | See solder reflow profile |
| ESD Min. - Charged Device Model (CDM) | 150 V |
| ESD Min. - Human Body Model (HBM) | 500 V |

2. Operation of this device above any one of these parameters may cause permanent damage.
3. Channel temperature directly affects a device's MTTF. Channel temperature should be kept as low as possible to maximize lifetime.
4. For saturated performance it is recommended that the sum of $(3 \cdot V_{DD} + \text{abs}(V_{GG})) < 175 \text{ V}$.
5. Junction Temperature (T_J) = $T_C + \Theta_{JC} \cdot ((V \cdot I) - (P_{OUT} - P_{IN}))$

Typical transient thermal resistances:

1 ms pulse, 10% duty cycle, $\Theta_{JC} = 5.0^\circ\text{C/W}$

For $T_C = 85^\circ\text{C}$,

$T_J = 132^\circ\text{C}$ @ 50 V, 520 mA-pk, $P_{OUT} = 17.0 \text{ W}$, $P_{IN} = 0.5 \text{ W}$

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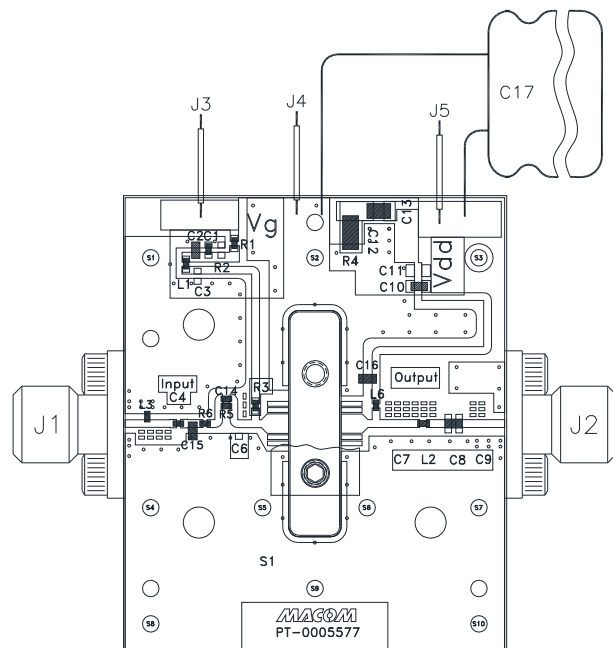
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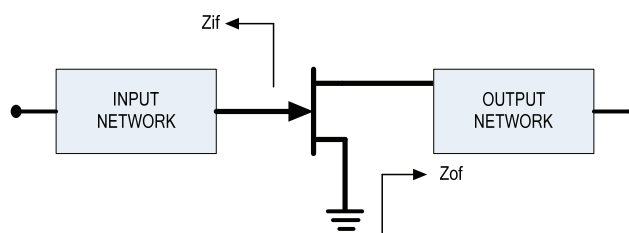
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Test Fixture Assembly (1.2 - 1.4 GHz, 1 ms Pulse, 10% Duty, $V_{DD} = 50$ V, $I_{dq} = 15$ mA)



Test Fixture Impedances

| F (GHz) | Z_{IF} (Ω) | Z_{OF} (Ω) |
|---------|-----------------------|-----------------------|
| 1.2 | $1.4 + j3.5$ | $2.5 + j3.5$ |
| 1.3 | $1.3 + j3.8$ | $2.7 + j3.9$ |
| 1.4 | $1.8 + j4.0$ | $3.1 + j4.2$ |



Parts List

| Reference Designator | Part | Vendor |
|------------------------------|--|------------------|
| C4 | 0402, 5.1 pF, ± 0.1 pF | ATC |
| C15 | 0603, 6.8 pF, ± 0.1 pF | ATC |
| C2 | 0603, 82 pF, $\pm 10\%$ | ATC |
| C16 | 0603, 100 pF, $\pm 10\%$ | ATC |
| C1, C10 | 0402, 1000 pF, 100 V, 5% | ATC |
| C8 | 0603, 30 pF, $\pm 10\%$ | ATC |
| C13 | 0805, 1 μ F, 100 V, $\pm 20\%$ | ATC |
| C14 | 0402, 12 pF, $\pm 10\%$ | ATC |
| C17 | 100 μ F, 160 V, Electrolytic Capacitor | Panasonic |
| C3, C6, C7, C9, C11, C12, R2 | Do Not Populate | - |
| R3 | 240 Ω , 0603, 5% | Panasonic |
| L1, R1 | 1.0 Ω , 0402, 5% | Panasonic |
| R4 | 1.0 Ω , 1206, 5% | Panasonic |
| R5 | 10 Ω , 0402, 5% | Panasonic |
| L3, L6 | 0402, 3.9 nH, 2% | Coilcraft |
| L2, R6 | 0402, 0.0 Ω Resistor | Panasonic |
| J1, J2 | SMA Connector | Tyco Electronics |

4 Contact factory for Gerber file or additional circuit information.

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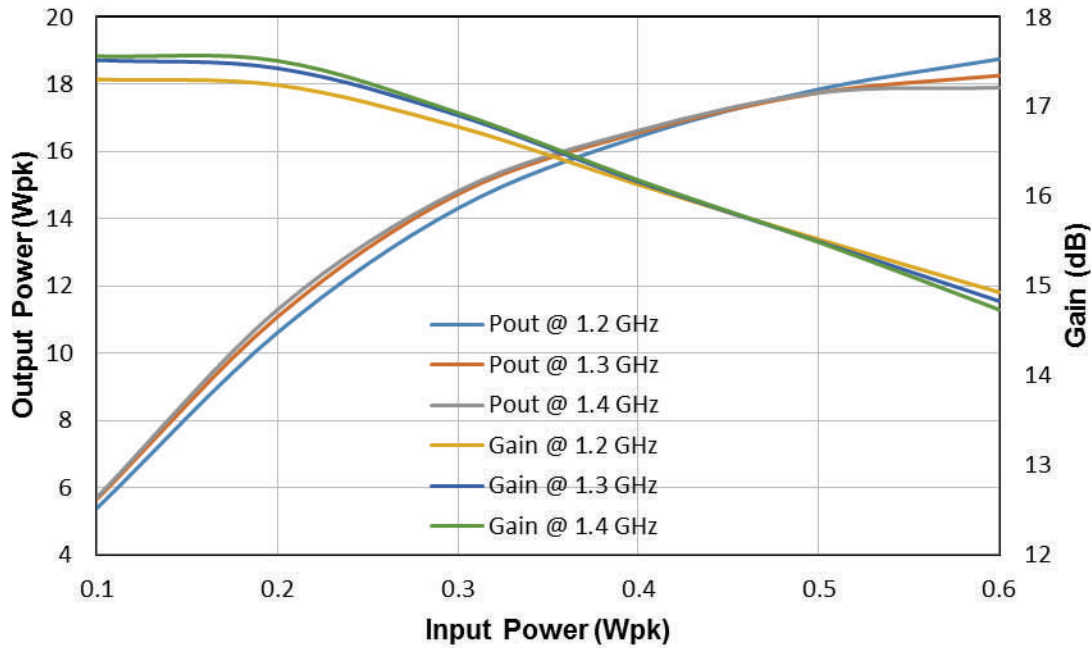
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Application Section

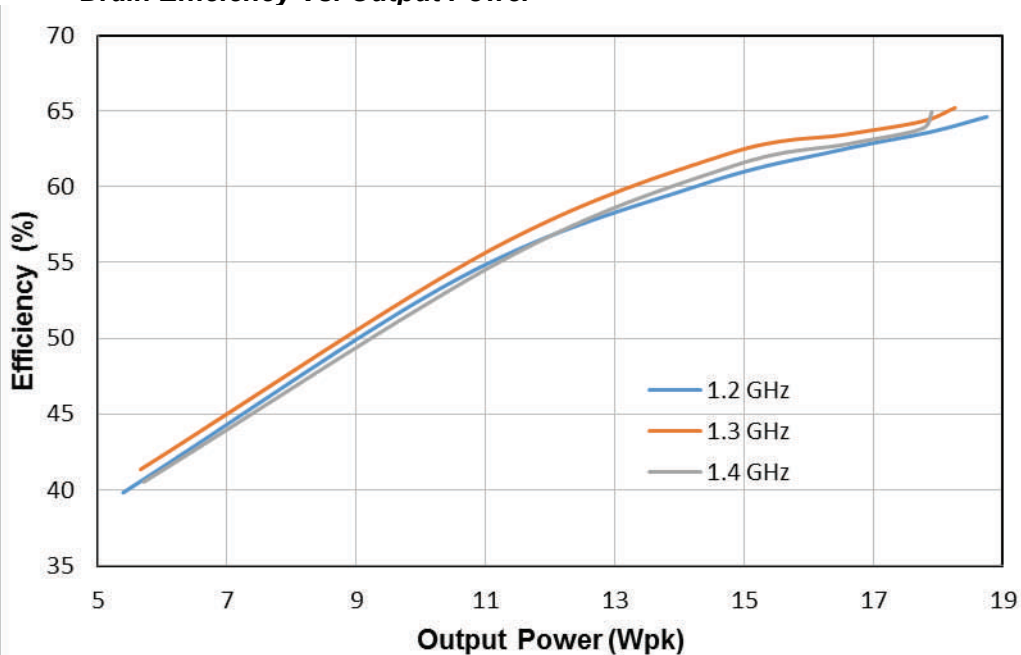
Typical Performance Curves

1.2 - 1.4 GHz, 1 ms Pulse, 10% Duty, $V_{DD} = 50\text{ V}$, $I_{dq} = 15\text{ mA}$, $T_A = 25^\circ\text{C}$

Output Power and Gain Vs. Input Power



Drain Efficiency Vs. Output Power



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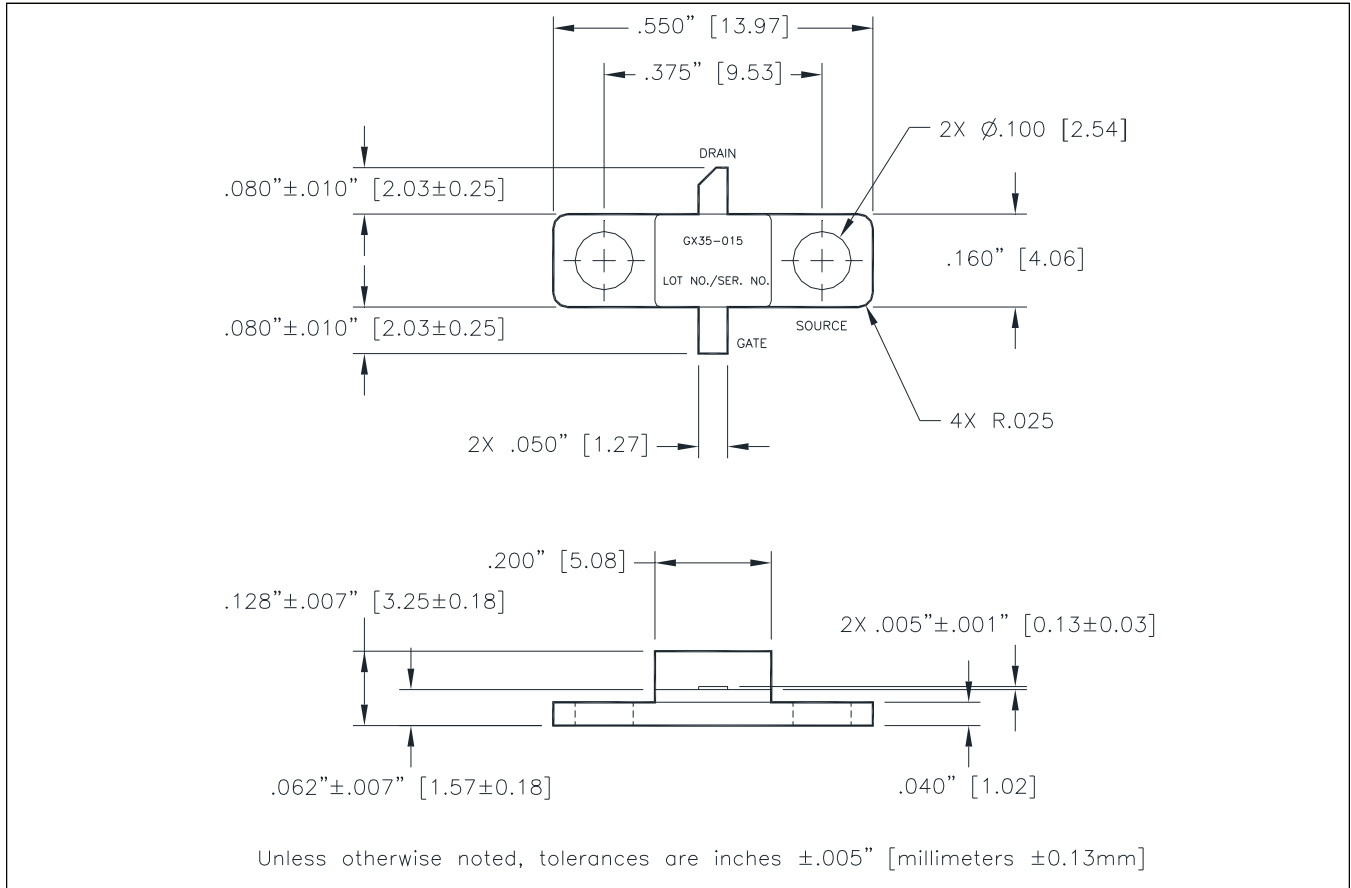
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Outline Drawing MAGX-000035-015000 (Flanged)



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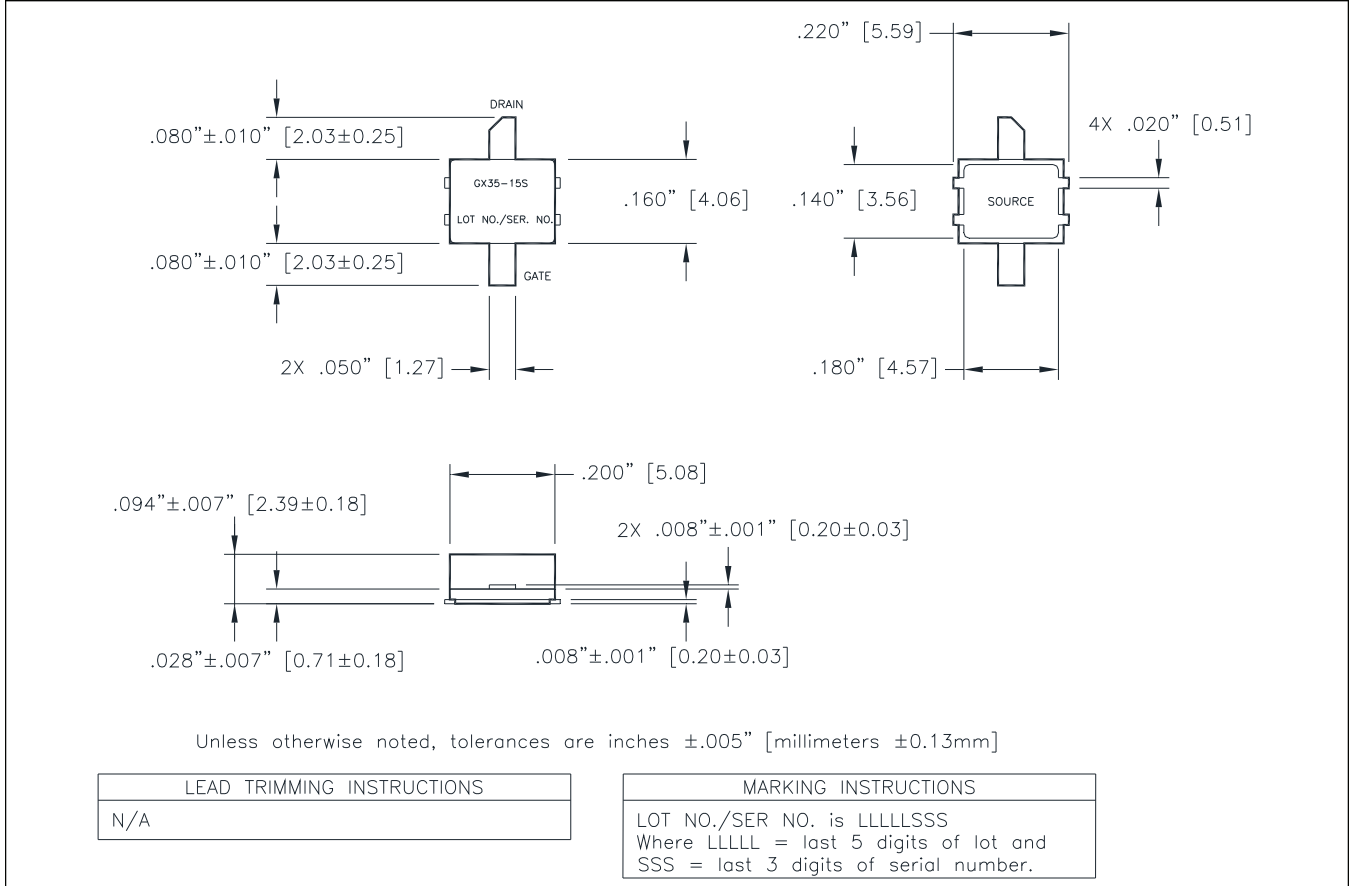
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Outline Drawing MAGX-000035-01500S (Flangeless)



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